



■ Typical Specifications



Items	Specifications		
	RDC40	RDC50	RDC90
Rated voltage	5V DC		
Operating life	100,000 cycles	1,000,000 cycles	10,000,000 cycles
Total resistance	10kΩ		3.3kΩ (RDC9010006) 10kΩ (RDC9010007)
Operating temperature range	-30°C to +80°C		-40°C to +120°C

■ Product Line



Mounting method	Linearity guarantee range	Linearity	Hollow shaft variation	Operating life (cycles)	Minimum order unit (pcs.)		Model No.	Drawing No.
					Japan	Export		
Connector type	13 rotations	±1%	—	100,000	770	770	RDC401D07A	1
Horizontal type	320°	±2%	φ3.5 dia	1,000,000	1,500	3,000	RDC501051A	2
			φ3.5 dia with radius				RDC501052A	3
Vertical type			φ3.5 dia		1,600	1,600	RDC502012A	4
Reflow type			φ3.5 dia with radius		3,900	3,900	RDC503051A	5
			φ3.5 dia with radius		3,900	3,900	RDC503052A	6
Reflow type (Low-profile)			φ4 dia		3,600	3,600	RDC506018A	7
Reflow type (Long-life)	60°	±3%	φ3.5 dia	10,000,000	1,960	1,960	RDC9010006	8
	244°						RDC9010007	

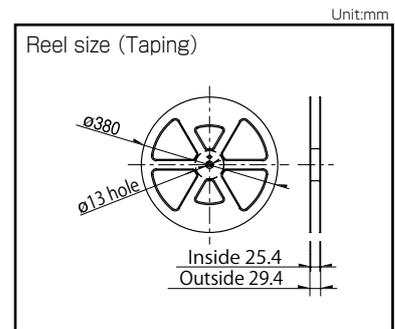
Note

Other varieties are also available. Please inquire.

■ Packing Specifications

Tray / Taping

Series	Packing Specifications	Number of packages (pcs.)		Tape width (mm)	Export package measurements (mm)
		1 case / Japan	1 case / export packing		
RDC40	Tray	770	770	—	526×370×191
RDC501		1,500	3,000		
RDC502		1,600	1,600		
RDC503	Taping	3,900	3,900	24	415×407×135
RDC506		3,600	3,600		
RDC90	Tray	1,960	1,960	—	300×240×270



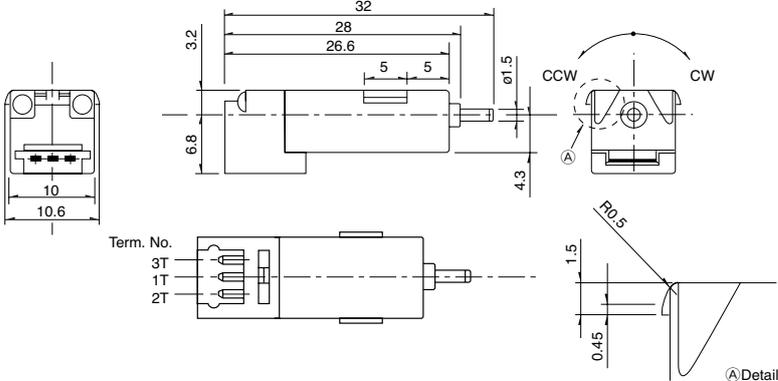
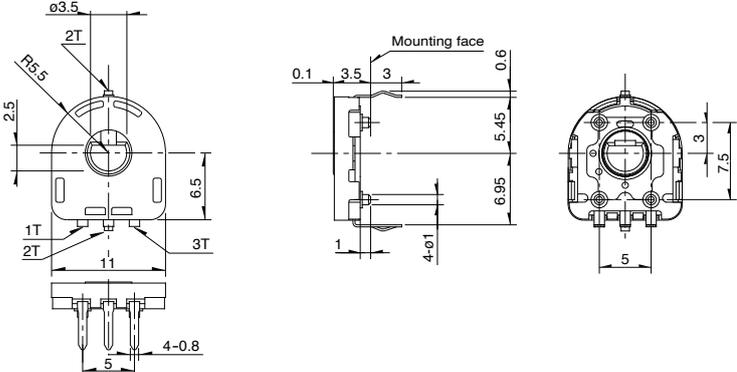
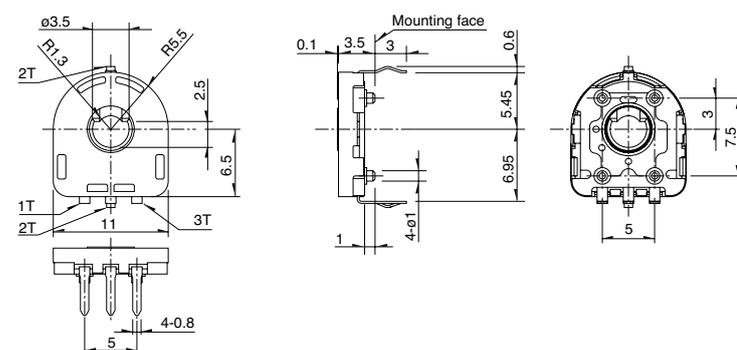
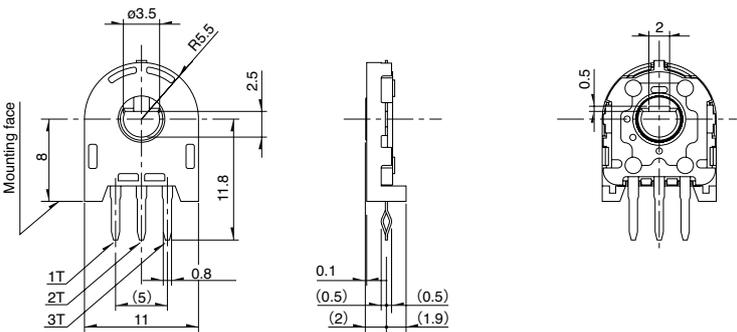
*Products marked with a are not recommended for new designs

Refer to P.466 for product specifications.
Refer to P.467 for soldering conditions.

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■ Dimensions

Unit:mm

No.	Photo	Style
1	<p>RDC40 (Multiple turns type)</p>  	 <p>Term. No. 3T 1T 2T</p> <p>CCW CW</p> <p>Ⓐ Detail</p>
2	<p>RDC501 (Horizontal type)</p> 	 <p>Mounting face</p>
3	<p>RDC501 (Horizontal type, $\phi 3.5$ dia with radius)</p> 	 <p>Mounting face</p>
4	<p>RDC502 (Vertical type)</p> 	 <p>Mounting face</p>

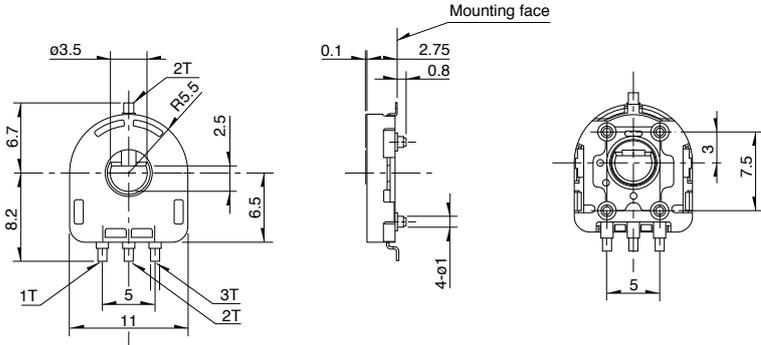
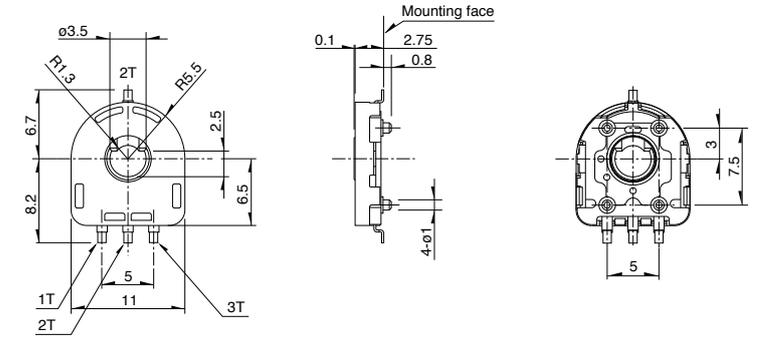
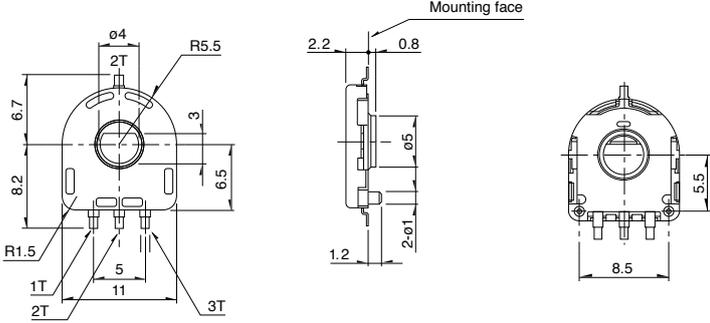
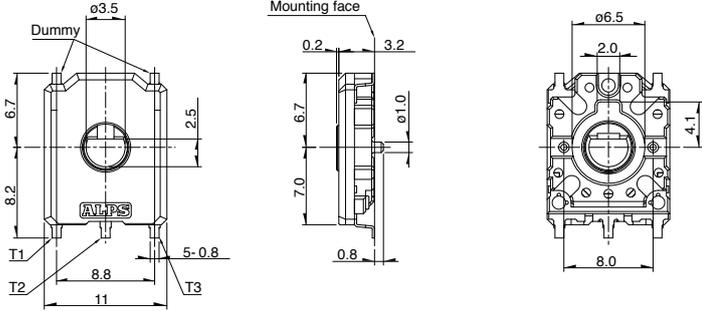
Resistive
Position Sensors

Rotary Type

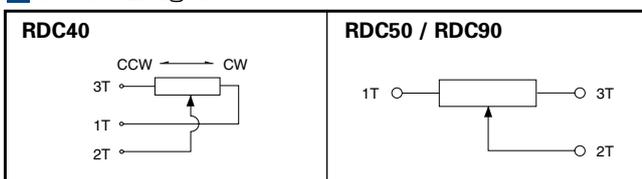
Linear Type

■ Dimensions

Unit:mm

No.	Photo	Style
5		
6		
7		
8		

■ Circuit Diagram



Resistive Position Sensors

List of Varieties

Type	Rotary Type			
Series	RDC40	RDC50	RDC90	RD6R1A
Photo				
Direction of lever	Horizontal	Vertical Horizontal	Vertical	
Effective electrical angle (°)	5,400 (15 rotations)	333.3	80, 260	320
Linearity guarantee range (°)	4,680 (13 rotations)	320	60, 244	310
Travel	—	—	—	—
Operating temperature range	−30°C to +80°C	−40°C to +120°C		−40°C to +85°C
Operating life	100,000 cycles	1,000,000 cycles	10,000,000 cycles	500,000 cycles
Available for automotive use	—	●	●	●
Life cycle (availability)				
Mechanical performance	Operating force	—	—	—
	Rotational torque	1.96mN·m max.	2mN·m max.	
Electrical performance	Total resistance tolerance	±30%		±20%
	Linearity (%)	±1	±2	±3
	Rated voltage (V DC)	5		
Environmental performance	Cold	−30°C 240h	−40°C 168h	
	Dry heat	80°C 240h	120°C 168h	85°C 168h
	Damp heat	60°C, 90 to 95%RH 240h	60°C, 90 to 95%RH 96h	
Terminal style	Connector	Insertion / Reflow	Reflow	Connector
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Note

● Indicates applicability to all products in the series.

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Reference for Manual Soldering

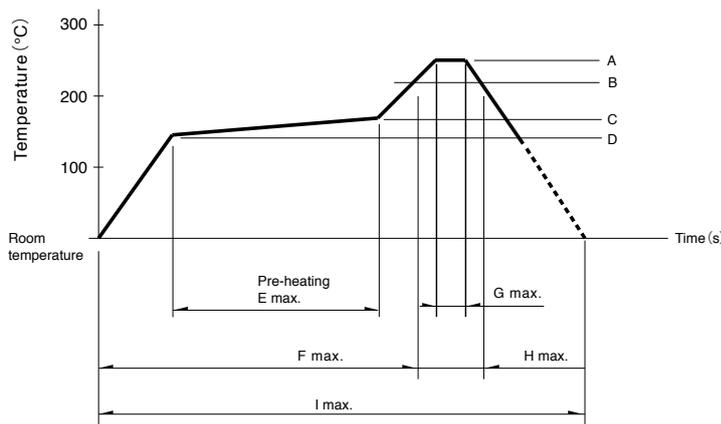
Series	Tip temperature	Soldering time
RDC50, RDC90	350±5°C	3 ⁺¹ ₀ s
RDC10, RD7	350°C max.	3s max.

Reference for Dip Soldering

Series	Preheating		Dip soldering		No. of solders
	Soldering surface temperature	Heating time	Soldering temperature	Soldering time	
RDC501, RDC502	100 to 150°C	1minute max.	260±5°C	10±1s	1 time
RD7	100°C max.	1minute max.	260°C max.	5s max.	1 time

Example of Reflow Soldering Condition

1. Cleaning sensors should not be attempted.
2. Type of solder to be used Use cream solder that contains 10 to 15 %wt flux.
3. Number of solder applications - apply solder only once
4. Recommended reflow conditions



Series	A	B	C	D	E	F	G	H	I	No. of reflows
RDC503 RDC506	250°C	230°C	180°C	150°C	2min.	—	5s	40s	4min.	1 time
RDC90	255°C	230°C	—	—	—	2min.	10s	1min.	4min.	1 time

Notes

1. When using an infrared reflow oven, solder may not always be applied as intended. Be sure to use a hot air reflow oven or a type that uses infrared rays in combination with hot air.
2. The temperatures given above are the maximum temperatures at the terminals of the sensor when employing a hot air reflow method. The temperature of the PC board and the surface temperature of the sensor may vary greatly depending on the PC board material, its size and thickness. Ensure that the surface temperature of the sensor does not rise to 250°C or greater.
3. Conditions vary to some extent depending on the type of reflow bath used. Be sure to give due consideration to this prior to use.